#### 505281970 01/16/2019

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5328744

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
SANG-UK KIM	12/04/2018

### **RECEIVING PARTY DATA**

Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16249446

### **CORRESPONDENCE DATA**

Fax Number: (703)207-0003

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

703.207.0008 Phone: Email: eoa@lee-iplaw.com **Correspondent Name: EUGENE M LEE** Address Line 1: LEE & MORSE, P.C.

Address Line 2: 3141 FAIRVIEW PARK DRIVE, SUITE 500

Address Line 4: FALLS CHURCH, VIRGINIA 22042

ATTORNEY DOCKET NUMBER:	239/1215_00
NAME OF SUBMITTER:	EUGENE M. LEE
SIGNATURE:	/Eugene M. Lee/
DATE SIGNED:	01/16/2019
	This document serves as an Oath/Declaration (37 CFR 1.63).

# **Total Attachments: 3**

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> **PATENT REEL: 048035 FRAME: 0778**

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# COMBINED DECLARATION (37 CFR §1.63) FOR UTILITY PATENT APPLICATION AND ASSIGNMENT FORM!

The undersigned acknowledges that this document is being used both as an assignment of the invention and as the declaration (37 CFR 1.63) for a Utility or Design Application.

WHEREAS, the undersigned, hereinafter referred to collectively as Assignor, has invented:

Title:	SEMICONDUCTOR PACKAGE AND METHOD OF SAME	FABRICATING THE
for whi patent.	ich Assignor is about to make or has made United States or	International application for
WHER	EAS, as a below named inventor(s), I/(we) hereby declare t	hat;
Section	1. Declaration	
This de	claration is directed to the attached U.S. non-provisional pang is marked:	tent application, unless the
	U.S. non-provisional patent application number or	, filed on
	PCT international patent application number	, filed on
	as amended by the Preliminary Amendment attac	hed hereto.
	as amended by the Preliminary Amendment filed	
The abo	ve-identified application was made or authorized to be mad	e by me (us).
I (we) b inventio	elieve that I am (we are) the original inventor (original joint n in the above-identified application.	inventors) of a claimed
l (we) ho under 18	ereby acknowledge that any willful false statement made in BU.S.C. 1001 by fine or imprisonment of not more than five	this declaration is punishable (5) years, or both.
l hereby applicati	state that I have reviewed and understand the contents of thon, including the claims (as amended by any amendment re	e above identified ferred to above).
l acknow patentab	vledge that I am aware of the duty to disclose information willity as defined in 37 CFR § 1.56.	hich is material to
This for	m requires the use of an Application Data Sheet.	
SEC Ref	No. <u>IE-201804-017-1-US0</u> Attorney Ref No.	239/1215_00
CON	MBINED DECLARATION (37 CFR. 1.63) FOR UTILITY PATE ASSIGNMENT FORM	

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### SAMSUNG ELECTRONICS CO., LTD.

### Section II. Assignment

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned hereby sell(s) and assign(s) to

### Samsung Electronics Co., Ltd.

having an address at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do 16677 Republic of Korea (hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in Section I of this document.

Assignor hereby confirms any prior assignment to Assignee, and to the extent that Assignor has not already done so, agrees to assign, and hereby does, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, fitle and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights:

Assignor hereby covenants and agrees to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

Assignor hereby covenants that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment; and

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## SAMSUNG ELECTRONICS CO., LTD.

Assignor hereby requests the United States Patent and Trademark Office to issue the Letters Patent of the United States of America to Assignee, and requests that any official of any country or countries foreign to the United States, whose duty it is to issue or grant patents and applications as aforesaid, to issue the Letters Patent, Utility Model Registration or other similar right to Assignee.

The undersigned hereby grant(s) the law firm of LEE & MORSE, P.C. the power to insert on this Declaration and Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

# Section III. Inventor(s)/Assignor(s) Signature(s)

LEGAL NAME OF FIRST	Family Name	First Given Name	Second Given Name
INVENTOR/ASSIGNOR	KIM	Sang-Uk	
	A 14 W		
SIGNATURE _	4449	DATE	18, 12.4

Parabana 深性性性肾髓 细胞 维尔斯克斯 经收益的文字数据

SEC Ref No.	IE-201804-017-1-US0	Attorney Ref No.	239/1215 00

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